### Switching Diodes

**Panasonic** 

# **MAS3132DG**

### Silicon epitaxial planar type

#### For switching circuits

#### Features

- Two elements are contained in one package, allowing highdensity mounting
- Short reverse recovery time t<sub>rr</sub>
- Small terminal capacitance C<sub>t</sub>

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter		Symbol	Rating	Unit	
Reverse voltage		V <sub>R</sub>	80	V	
Maximum peak reverse voltage		V <sub>RM</sub>	80	V	
Forward current	Single	I <sub>F</sub>	100	mA	
	Double		150		
Peak forward current	Single	I <sub>FM</sub>	225	mA	
	Double		340		
Non-repetitive peak	Single	I <sub>FSM</sub>	500	mA	
forward surge current *	Double		750		
Junction temperature		Tj	150	°C	
Storage temperature		T <sub>stg</sub>	-55 to +150	Soc o	
			$\overline{\alpha}$		



- Pin Name
- 1: Cathode 1
- 2: Cathode 2
- 2: Cauloue 2 3: Anode 1, 2

Marking Symbol: MO

Internal Connection



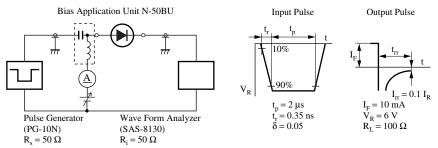
Note) \*: t = 1 s

#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

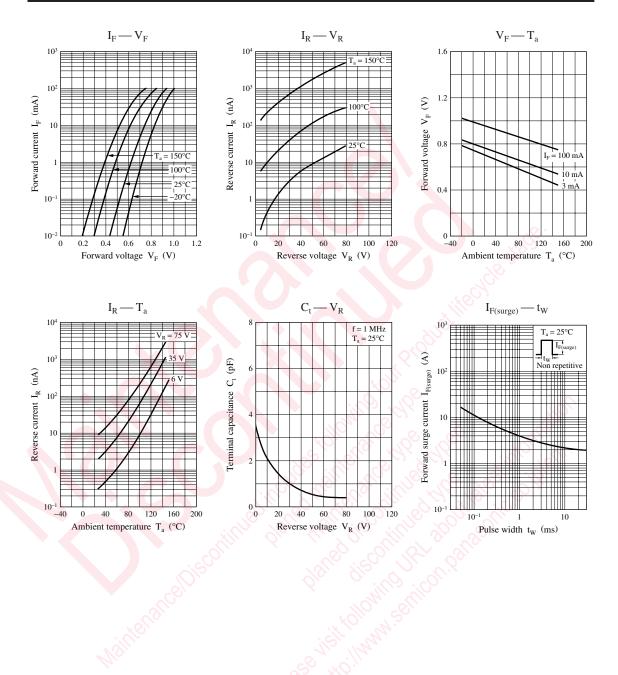
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	S V <sub>F</sub>	I <sub>F</sub> = 100 mA	.?		1.2	V
Reverse voltage	V <sub>R</sub>	I <sub>R</sub> = 100 μA	80			V
Reverse current	I <sub>R</sub>	V <sub>R</sub> = 75 V			100	nA
Terminal capacitance	Ct	$V_R = 0 V, f = 1 MHz$			15	pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}$			10	ns
		$I_{rr} = 0.1 I_R$ , $R_L = 100 \Omega$				

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring method for diodes.

- 2. Absolute frequency of input and output is 100 MHz.
- 3. \*: t<sub>rr</sub> measurement circuit



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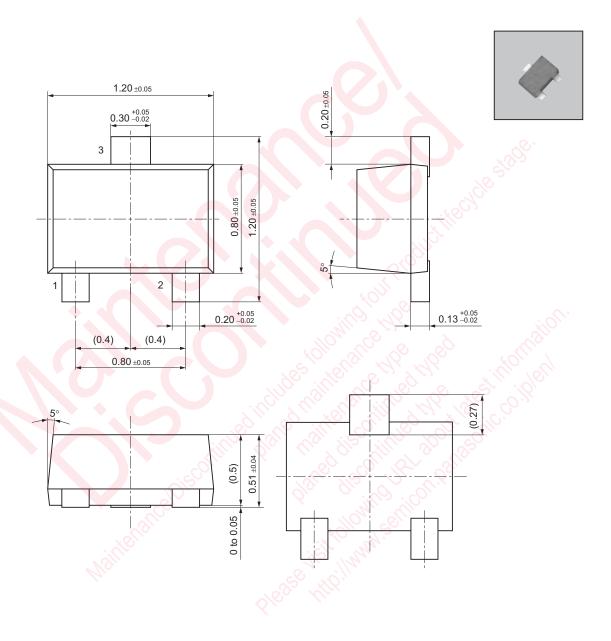


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MAS3132DG

### SSSMini3-F2

Unit: mm



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